

**In the Specification:**

Please amend the title of the application as follows:

~~METHOD AND MICROELECTRONIC ASSEMBLIES, ELECTRONIC DEVICES,~~  
AND APPARATUSES FOR SUPPORTING MICROELECTRONIC SUBSTRATES

Please add a new section directly before "BACKGROUND" as follows:

**CROSS-REFERENCE TO RELATED APPLICATIONS**

This application is a divisional application of U.S. Patent Application No. 10/034,924, filed December 26, 2001, entitled "APPARATUS FOR SUPPORTING MICROELECTRONIC SUBSTRATES," now U.S. Patent No. \_\_\_\_\_, issued \_\_\_\_\_; and is related to U.S. Application No. 10/\_\_\_\_\_ [Attorney Docket No. 108298633US2], filed February 10, 2004, entitled "METHODS FOR COUPLING A FLOWABLE CONDUCTIVE MATERIAL TO MICROELECTRONIC SUBSTRATES," which is a divisional application of U.S. Application No. 10/034,924; both of which are herein incorporated by reference in their entireties.